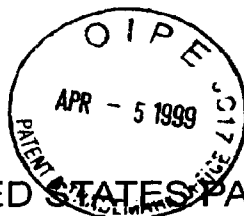


04-07-1999



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PATENT

Docket No.: MVI-004

UNITED STATES PATENT AND TRADEMARK OFFICE

4/5/99

RE

RECORDING COVER SHEET

1. Assignor: Jacson Liu
2. Assignee: MOSEL VITELIC INC.
No. 1, Creation Road I, Science-Based, Industrial Park,
Hsin-Chu, Taiwan, R.O.C.
3. Nature of Conveyance: Assignment of patent
4. Reference number: Application filed herewith. 09192019
5. Correspondence to: Winston Hsu
3F, No. 52, Lane 46, Min-Sheng Rd.,
Yung-Ho City, Taipei Hsien,
Taiwan, R.O.C.
6. Number of applications affected by this recording: 1
Total fee: (1 x \$ 40) = \$ 40.00 Payment enclosed
Authorization is hereby given to charge the over payment to deposit account #500801
7. Execution date of the document to be recorded: 11/05/1998
8. Total number of pages including cover sheet: 2
9. I declare under penalty of perjury that to the best of my knowledge and belief, the information contained on this cover sheet is true and correct, and that any copy submitted herewith is a true and correct copy of the original document.

ph

Date:

4/1/1999

Winston Hsu

Winston Hsu

U.S. Patent Agent

Registration Number: 41,526

ASSIGNMENT

I, (Assignor Name) Jacson Liu, residing at (Address) No. 14-7, 4 community, Hu-Kou burg, Hu-Kou, Hsin-Chu Hsien, Taiwan, R.O.C. have invented a device called A Shallow Trench Isolation Method of a Semiconductor Wafer.

(Assignee name) MOSEL VITELIC INC., (hereinafter "Assignee"), of (Assignee address) No. 1, Creation Rd, I, Science-Based Industrial Park, ^{Hsin-Chu, Taiwan, R.O.C.} wishes to acquire the entire right, title, and interest in and to the invention and to any letters patent that may be granted therefor in the United States and in any and all foreign countries.

Accordingly, in consideration of the sum of One Dollar, (\$1.00) to me in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, Assignor, hereby sells, assigns, and transfers to Assignee the full and exclusive right to the above described invention in the United States and its territorial possessions, and in all foreign countries. The rights granted include the entire right, title, and interest in and to any and all letters patent which may be granted on the invention, including any rights gained by divisions, reissues, continuations, and extensions of the above described application.

I hereby authorize and request the Patent and Trademark Office Officials in the United States and any and all foreign countries to issue any and all letters patent, when issued, to Assignee, as the assignee of my entire right, title, and interest in and to the invention, for the sole use and enjoyment of Assignee and its successors and assigns.

Further, I agree that I will communicate to Assignee or its representatives any facts known to me respecting the invention, to testify in any legal proceedings, to sign all lawful papers, to execute all divisions, continuations, substitutions, renewal and reissue applications, and to generally do those things necessary to aid Assignee and its successors and assigns to obtain and enforce proper protection for the invention in the United States and in any and all foreign countries.

Date: 11/05/1998 Jacson Liu
(Assignor Signature, with printed name below)

Jacson Liu